# 2SK0662 (2SK662)

### Silicon N-Channel Junction FET

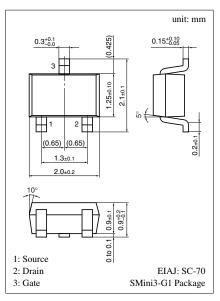
#### For low-frequency amplification

#### ■ Features

- $\bullet$  High mutual conductance  $g_{m}$
- Low noise type
- S-mini type package, allowing downsizing of the sets and automatic insertion through the tape/magazine packing.

#### ■ Absolute Maximum Ratings (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Drain to Source voltage	V <sub>DSX</sub>	30	V
Gate to Drain voltage	$V_{\mathrm{GDO}}$	-30	V
Drain current	$I_D$	20	mA
Gate current	$I_G$	10	mA
Allowable power dissipation	$P_{\mathrm{D}}$	150	mW
Junction temperature	Tj	125	°C
Storage temperature	T <sub>stg</sub>	-55 to +125	°C



Marking Symbol (Example): 10

#### ■ Electrical Characteristics (Ta = 25°C)

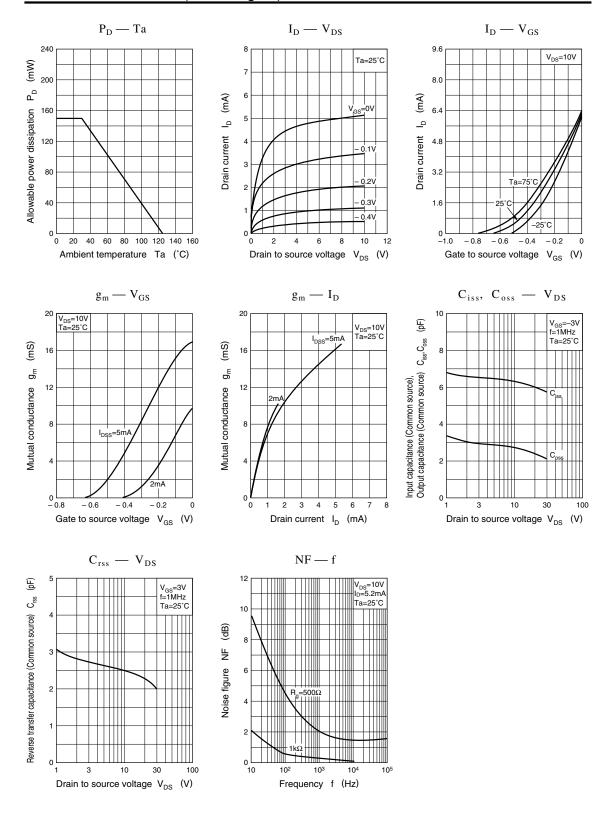
Parameter	Symbol	Conditions	min	typ	max	Unit
Drain to Source cut-off current	${\rm I_{DSS}}^*$	$V_{DS} = 10V, V_{GS} = 0$	0.5		12	mA
Gate to Source leakage current	$I_{GSS}$	$V_{GS} = -30V, V_{DS} = 0$			-100	nA
Gate to Source cut-off voltage	$V_{GSC}$	$V_{DS} = 10V, I_{D} = 10\mu A$	- 0.1		-1.5	V
Mutual conductance	g <sub>m</sub>	$V_{DS} = 10V, I_D = 0.5mA, f = 1kHz$	4			mS
		$V_{DS} = 10V, V_{GS} = 0, f = 1kHz$	4			
Input capacitance (Common Source)	C <sub>iss</sub>	$V_{DS} = 10V, V_{GS} = 0, f = 1MHz$		14		p F
Reverse transfer capacitance (Common Source)	C <sub>rss</sub>	$\mathbf{v}_{\mathrm{DS}} = 10  \mathbf{v}, \ \mathbf{v}_{\mathrm{GS}} = 0, 1 = 10  \mathrm{MHz}$		3.5		p F
Noise figure	NV	$V_{DS} = 30V, I_{D} = 1mA, G_{V} = 80dB$		60		mV
		$R_g = 100k\Omega$ , Function = FLAT		00		

#### \* IDSS rank classification

Runk	P	Q	R
I <sub>DSS</sub> (mA)	0.5 to 3	2 to 6	4 to 12
Marking Symbol	1OP	10Q	1OR

Note) The part number in the parenthesis shows conventional part number.

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